

N- and P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY

	V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)
N-Channel	40	0.027 at V _{GS} = 10 V	6.0	9.6
		0.032 at V _{GS} = 4.5 V	4.8	
P-Channel	- 40	0.029 at V _{GS} = - 10 V	- 6.0	21
		0.039 at V _{GS} = - 4.5 V	- 4.9	

FEATURES

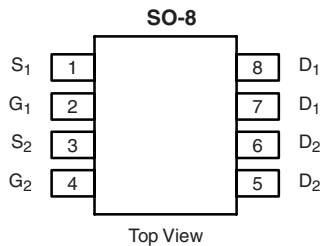
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

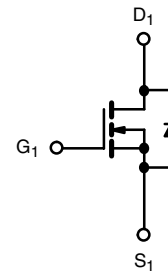
- CCFL Inverter



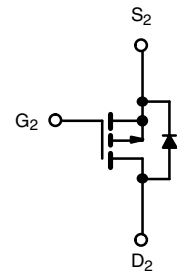
RoHS
COMPLIANT
HALOGEN
FREE
Available



Ordering Information: Si4569DY-T1-E3 (Lead (Pb)-free)
Si4569DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage		V _{DS}	40	- 40	V
Gate-Source Voltage		V _{GS}	± 16		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	I _D	7.6	- 7.9	A
	T _C = 70 °C		6.0	- 6.3	
	T _A = 25 °C		6.0 ^{b, c}	- 6.1 ^{b, c}	
	T _A = 70 °C		4.8 ^{b, c}	- 4.9 ^{b, c}	
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	20	- 20	
Source-Drain Current Diode Current	T _C = 25 °C	I _S	2.6	- 2.6	
	T _A = 25 °C		1.6 ^{b, c}	- 1.6 ^{b, c}	
Pulsed Source-Drain Current		I _{SM}	20	- 20	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	10	20	
Single Pulse Avalanche Energy		E _{AS}	5	20	mJ
Maximum Power Dissipation	T _C = 25 °C	P _D	3.1	3.2	W
	T _C = 70 °C		2	2.1	
	T _A = 25 °C		2 ^{b, c}	2 ^{b, c}	
	T _A = 70 °C		1.28 ^{b, c}	1.28 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient ^{b, d}	R _{thJA}	49	62.5	47	62.5	°C/W
Maximum Junction-to-Foot (Drain)	R _{thJF}	30	40	29	38	

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 120 °C/W (N-Channel) and 110 °C/W (P-Channel).

SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions		Min.	Typ. ^a	Max.	Unit		
Static									
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	N-Ch	40			V		
		V _{GS} = 0 V, I _D = - 250 μA	P-Ch	- 40					
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA	N-Ch		37				
		I _D = - 250 μA	P-Ch		- 38				
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA	N-Ch		- 5				
		I _D = - 250 μA	P-Ch		4.0				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	N-Ch	0.6		2.0			
		V _{DS} = V _{GS} , I _D = - 250 μA	P-Ch	- 0.8		- 2.2			
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 16 V	N-Ch P-Ch			100 - 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	N-Ch			1	μA		
		V _{DS} = - 40 V, V _{GS} = 0 V	P-Ch			- 1			
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 55 °C	N-Ch			10			
		V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 55 °C	P-Ch			- 10			
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	N-Ch	20			A		
		V _{DS} = - 5 V, V _{GS} = - 10 V	P-Ch	- 20					
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 6 A	N-Ch		0.022	0.027	Ω		
		V _{GS} = - 10 V, I _D = - 6 A	P-Ch		0.024	0.029			
		V _{GS} = 4.5 V, I _D = 4.8 A	N-Ch		0.026	0.032			
		V _{GS} = - 4.5 V, I _D = - 4.9 A	P-Ch		0.031	0.039			
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 6 A	N-Ch		20		S		
		V _{DS} = - 15 V, I _D = - 6 A	P-Ch		17				
Dynamic ^a									
Input Capacitance	C _{iss}	N-Channel V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz	N-Ch P-Ch		855 1505		pF		
Output Capacitance	C _{oss}		P-Channel V _{DS} = - 20 V, V _{GS} = 0 V, f = 1 MHz	N-Ch P-Ch		105 230			
Reverse Transfer Capacitance	C _{rss}			N-Ch P-Ch		65 175			
Total Gate Charge	Q _g	V _{DS} = 20 V, V _{GS} = 10 V, I _D = 5 A	N-Ch		21	32	nC		
		V _{DS} = - 20 V, V _{GS} = - 10 V, I _D = - 5 A	P-Ch		41	62			
Gate-Source Charge	Q _{gs}	N-Channel V _{DS} = 20 V, V _{GS} = 4.5 V, I _D = 5 A	N-Ch P-Ch		9.6 21	14.5 31			
			P-Channel V _{DS} = - 20 V, V _{GS} = - 4.5 V, I _D = - 5 A	N-Ch P-Ch		2.3 4.5			
		Gate-Drain Charge		Q _{gd}		N-Ch P-Ch			3.2 9.2
			Gate Resistance		R _g	f = 1 MHz		N-Ch P-Ch	



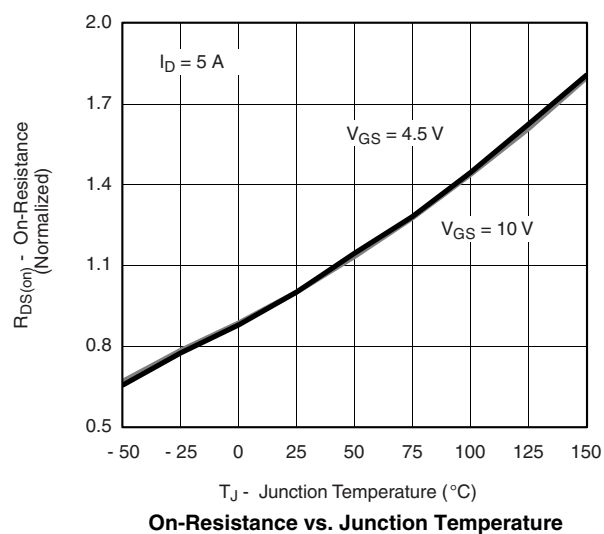
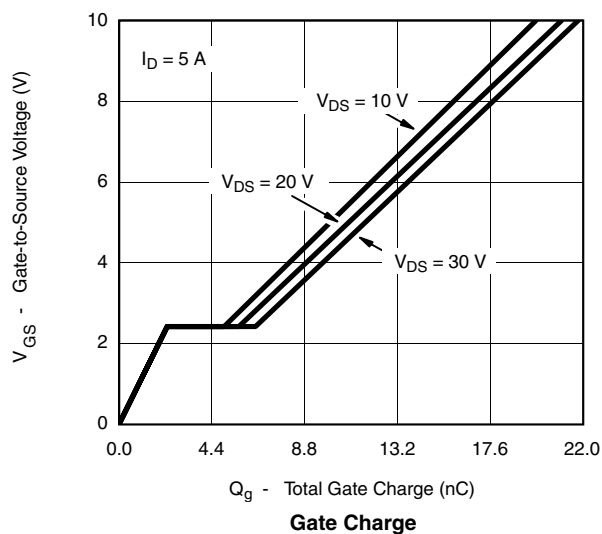
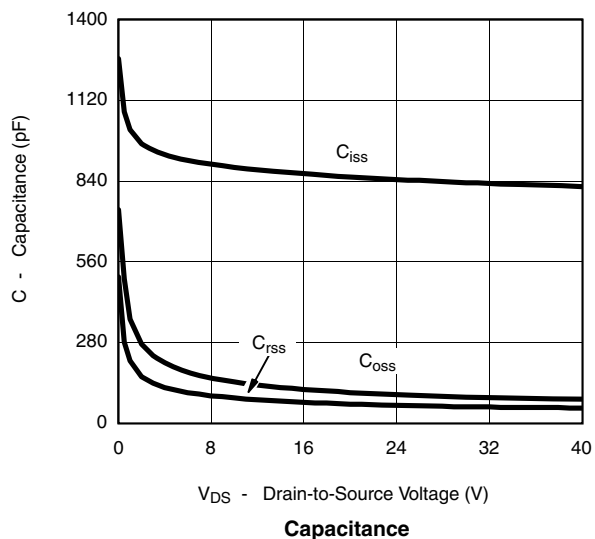
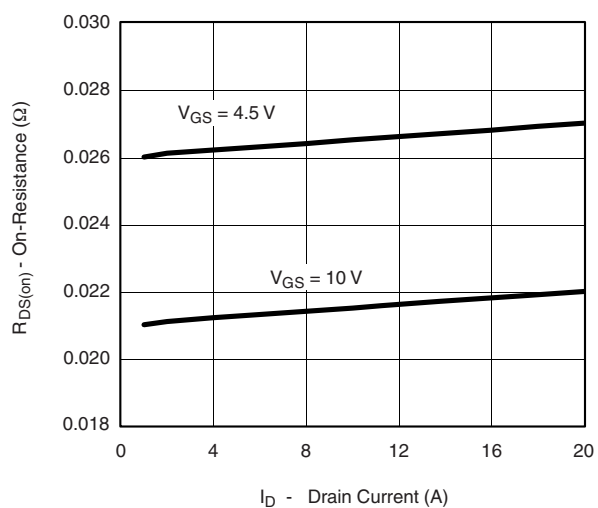
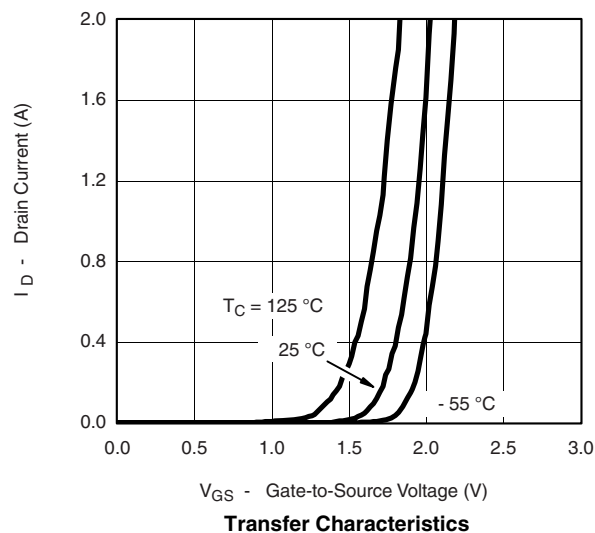
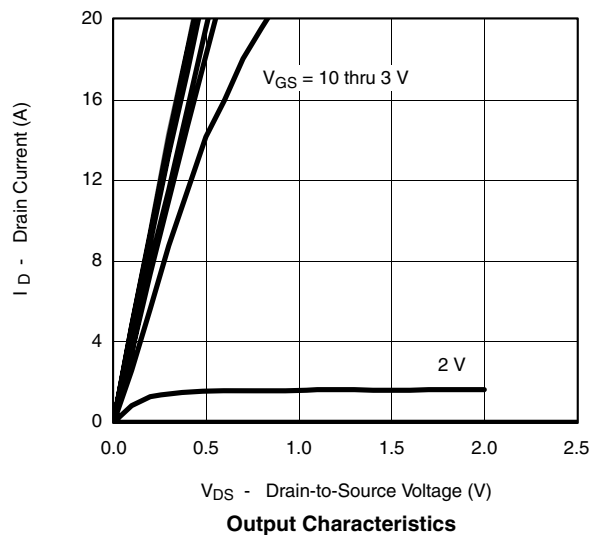
SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions		Min.	Typ. ^a	Max.	Unit
Dynamic ^a							
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}$, $R_L = 4\text{ }\Omega$ $I_D \cong 5\text{ A}$, $V_{GEN} = 10\text{ V}$, $R_g = 1\text{ }\Omega$	N-Ch		6	12	ns
			P-Ch		7	14	
Rise Time	t_r		N-Ch		11	20	
			P-Ch		15	25	
Turn-Off Delay Time	$t_{d(off)}$	P-Channel $V_{DD} = -20\text{ V}$, $R_L = 4\text{ }\Omega$ $I_D \cong -5\text{ A}$, $V_{GEN} = -10\text{ V}$, $R_g = 1\text{ }\Omega$	N-Ch		24	36	
			P-Ch		51	77	
Fall Time	t_f		N-Ch		6	12	
			P-Ch		54	81	
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}$, $R_L = 4\text{ }\Omega$ $I_D \cong 5\text{ A}$, $V_{GEN} = 4.5\text{ V}$, $R_g = 1\text{ }\Omega$	N-Ch		12	20	
			P-Ch		26	40	
Rise Time	t_r		N-Ch		60	90	
			P-Ch		105	160	
Turn-Off Delay Time	$t_{d(off)}$	P-Channel $V_{DD} = -20\text{ V}$, $R_L = 4\text{ }\Omega$ $I_D \cong -5\text{ A}$, $V_{GEN} = -4.5\text{ V}$, $R_g = 1\text{ }\Omega$	N-Ch		22	33	
			P-Ch		60	90	
Fall Time	t_f		N-Ch		5	10	
			P-Ch		60	90	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	$T_C = 25\text{ }^{\circ}\text{C}$	N-Ch			2.6	A
			P-Ch			- 2.6	
Pulse Diode Forward Current ^a	I_{SM}		N-Ch			20	
			P-Ch			- 20	
Body Diode Voltage	V_{SD}	$I_S = 1.5\text{ A}$	N-Ch		0.73	1.2	V
		$I_S = -1.6\text{ A}$	P-Ch		- 0.73	- 1.2	
Body Diode Reverse Recovery Time	t_{rr}	N-Channel $I_F = 5\text{ A}$, $dl/dt = 100\text{ A}/\mu\text{s}$, $T_J = 25\text{ }^{\circ}\text{C}$	N-Ch		26	40	ns
			P-Ch		30	45	
Body Diode Reverse Recovery Charge	Q_{rr}	P-Channel $I_F = -5\text{ A}$, $dl/dt = -100\text{ A}/\mu\text{s}$, $T_J = 25\text{ }^{\circ}\text{C}$	N-Ch		21	32	nC
			P-Ch		24	36	
Reverse Recovery Fall Time	t_a		N-Ch		13		ns
			P-Ch		15		
Reverse Recovery Rise Time	t_b	N-Ch		13			
		P-Ch		15			

Notes:

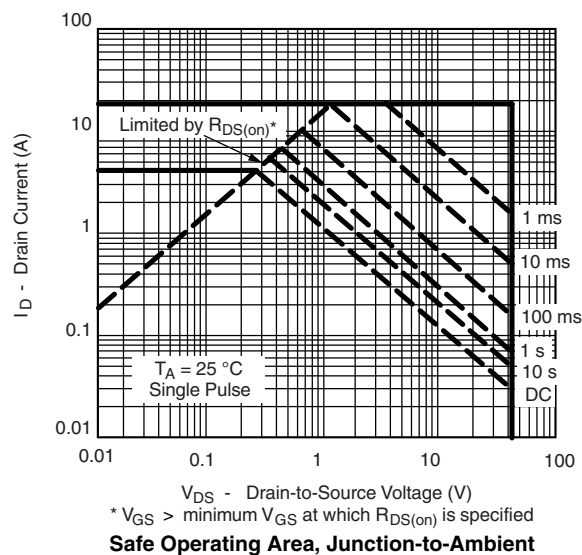
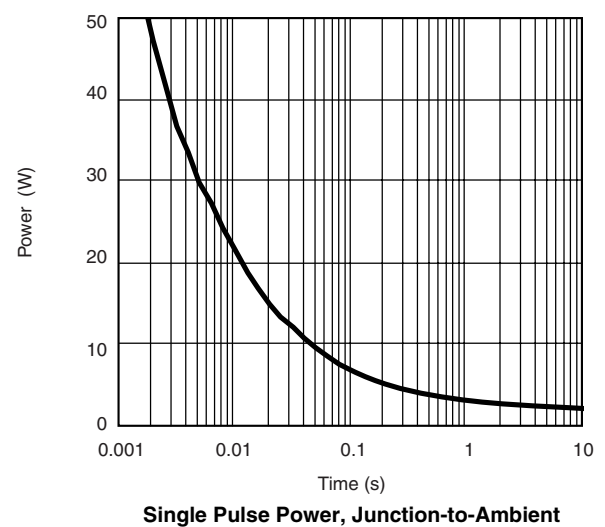
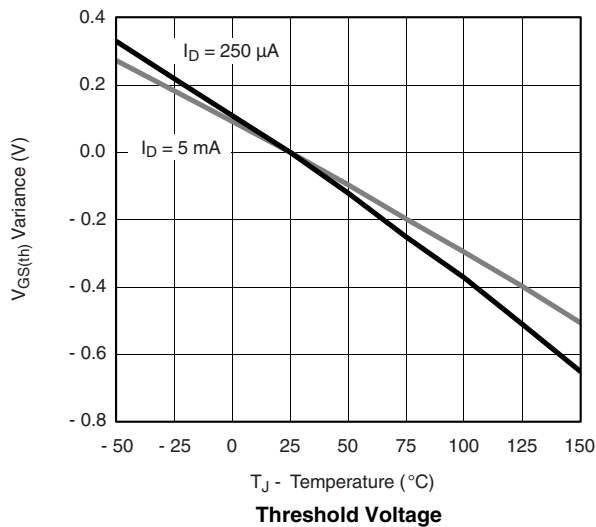
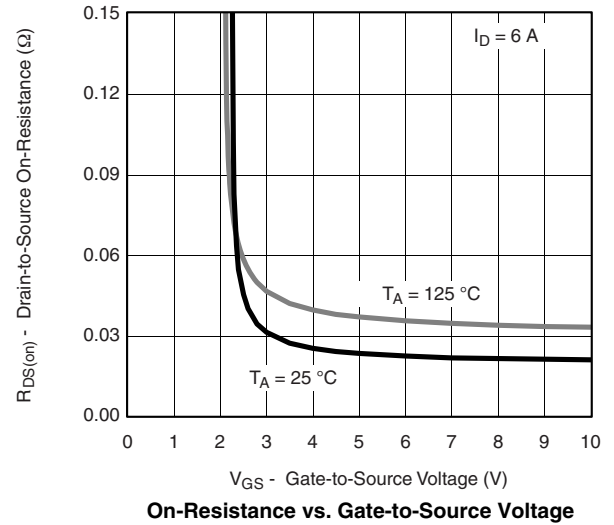
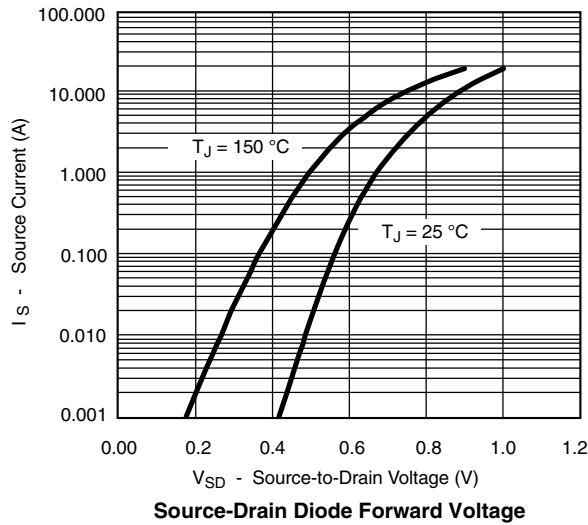
a. Guaranteed by design, not subject to production testing.

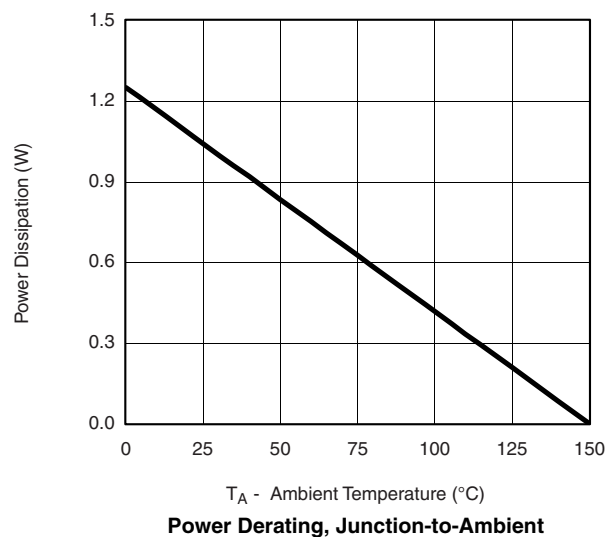
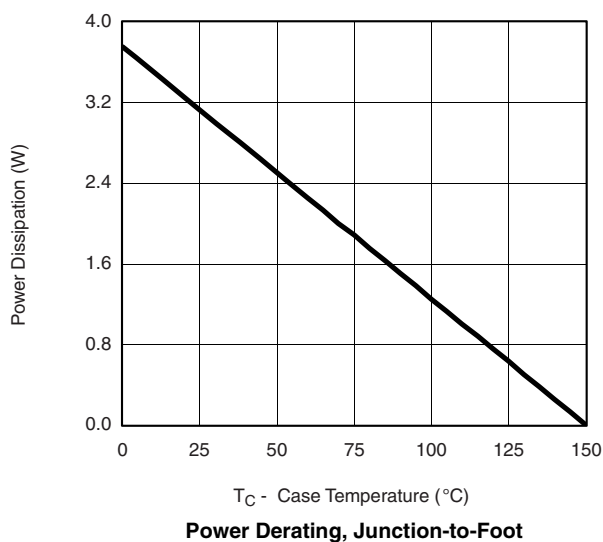
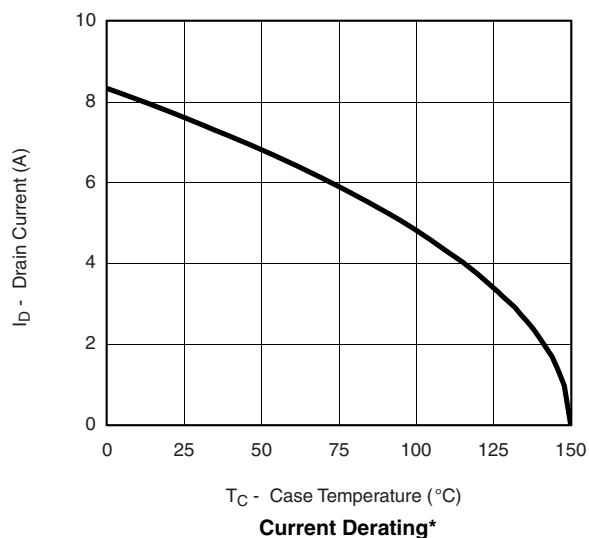
b. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

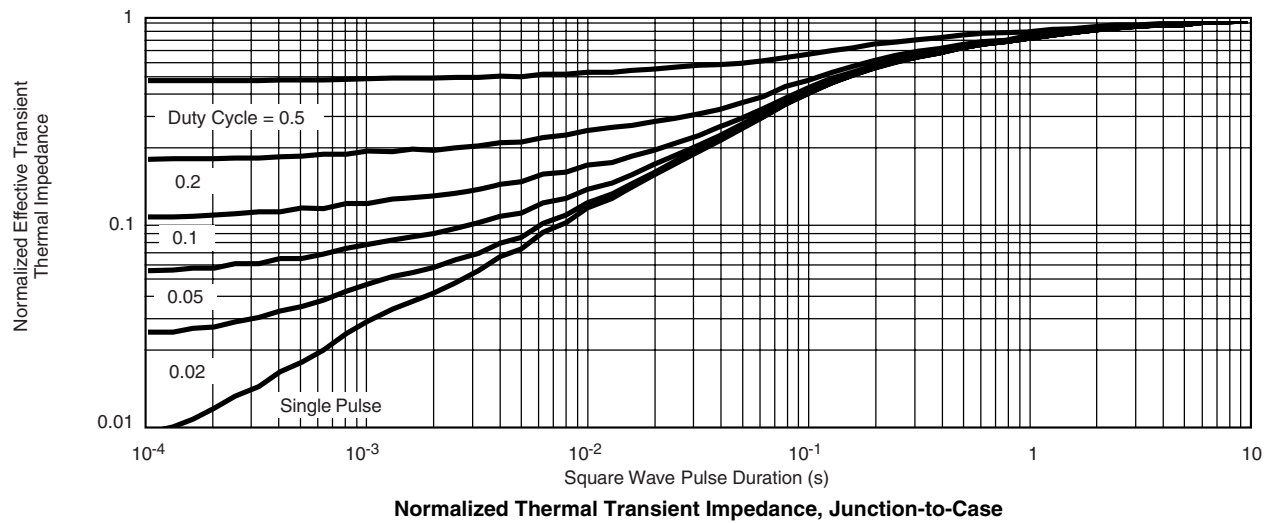
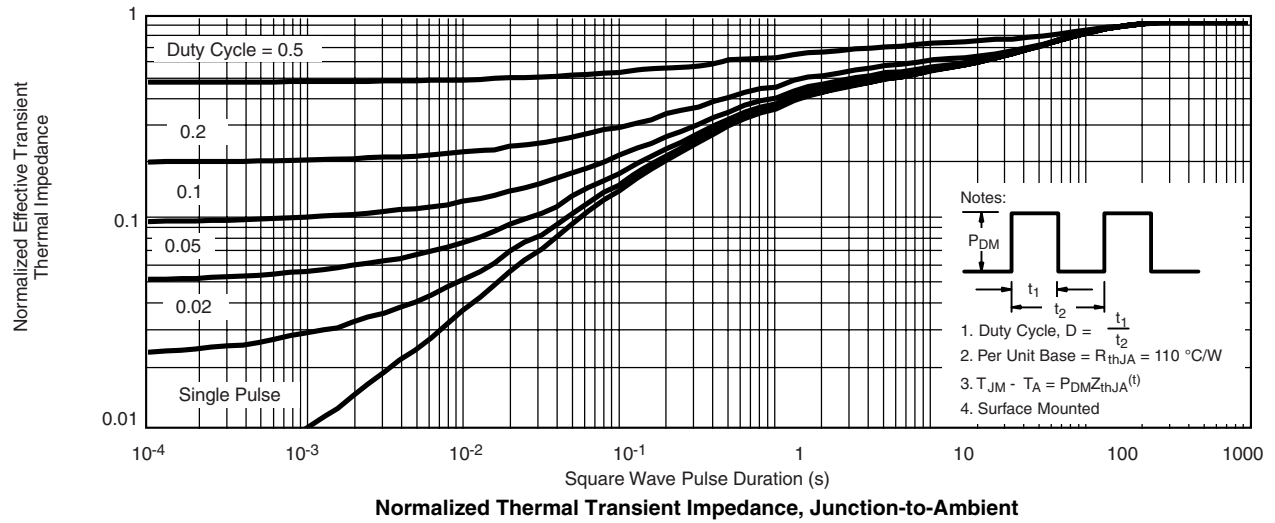
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

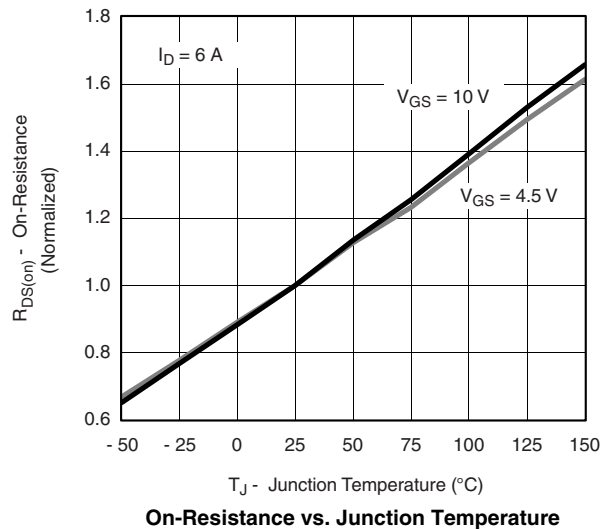
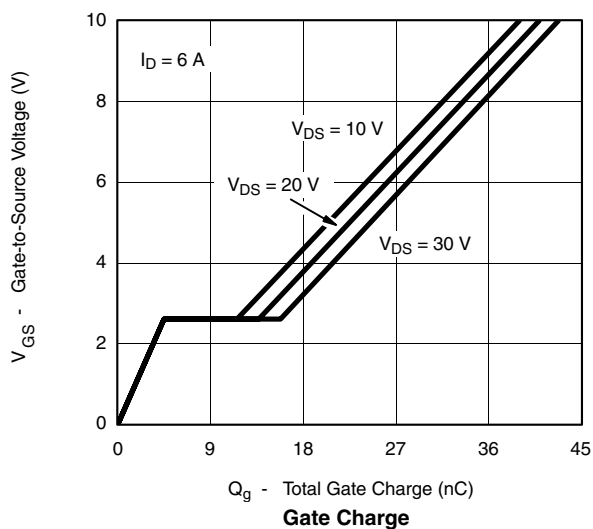
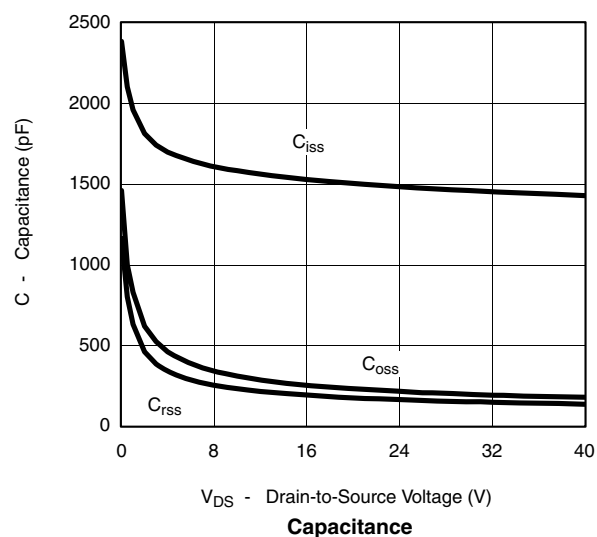
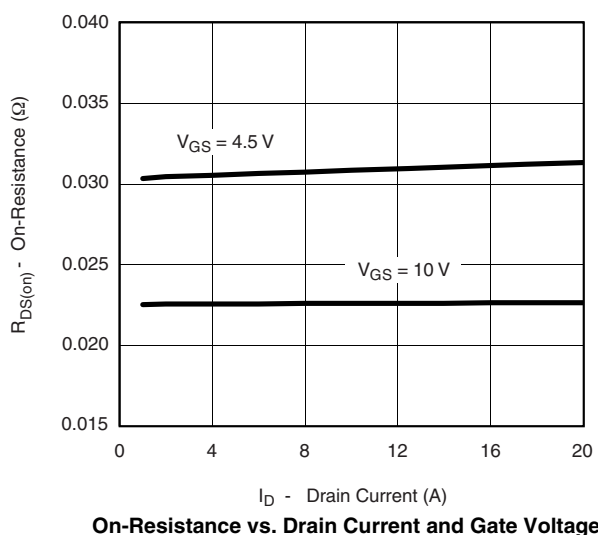
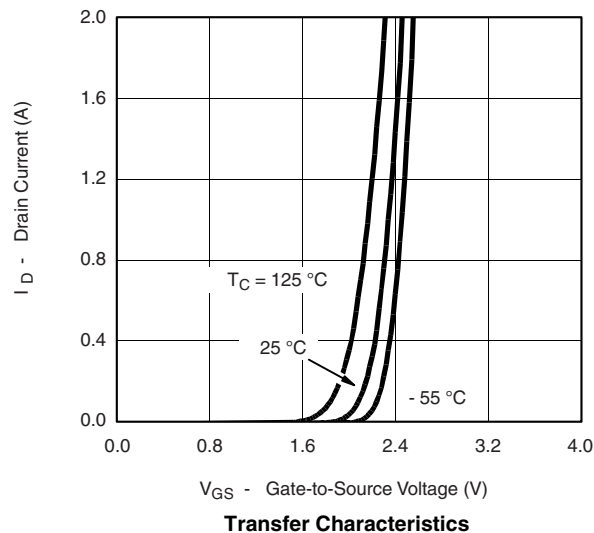
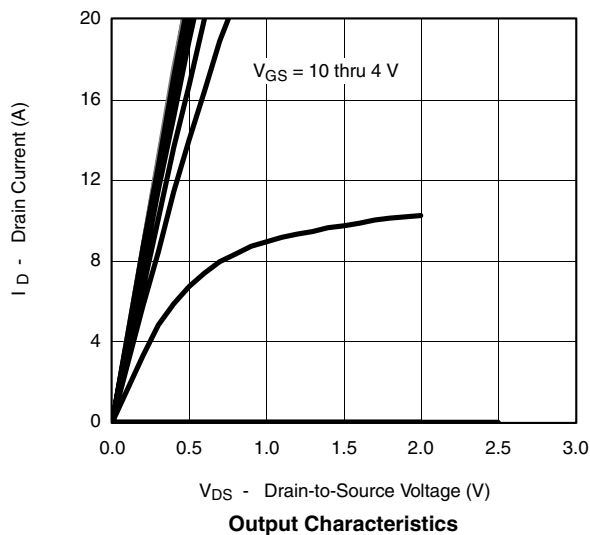


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

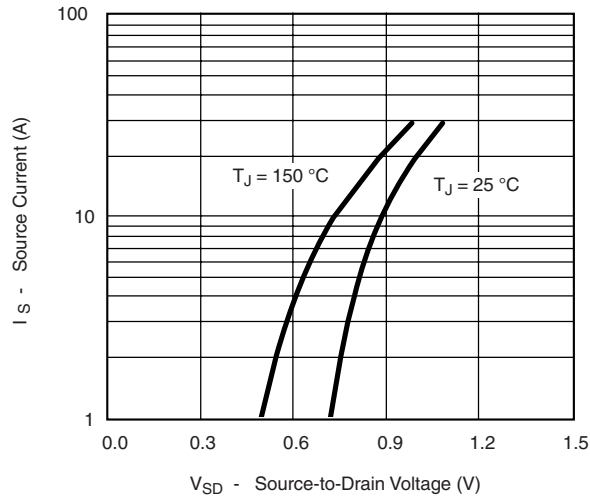
* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

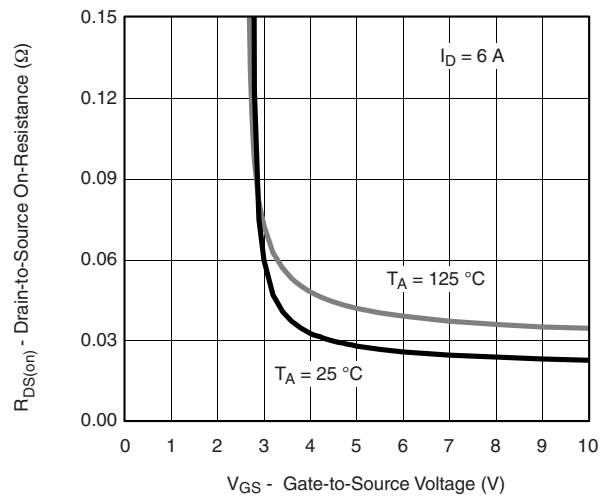


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

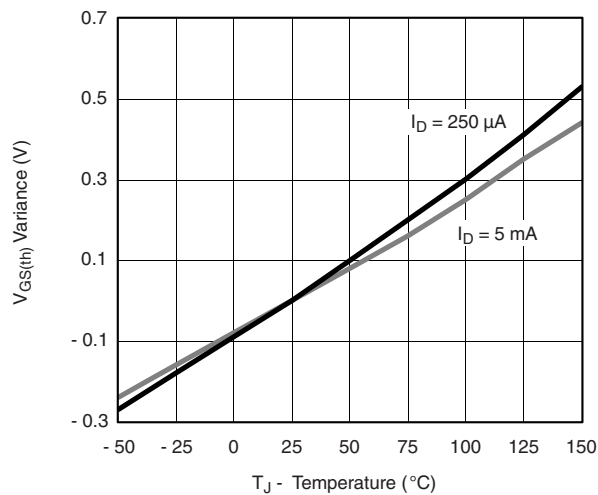
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



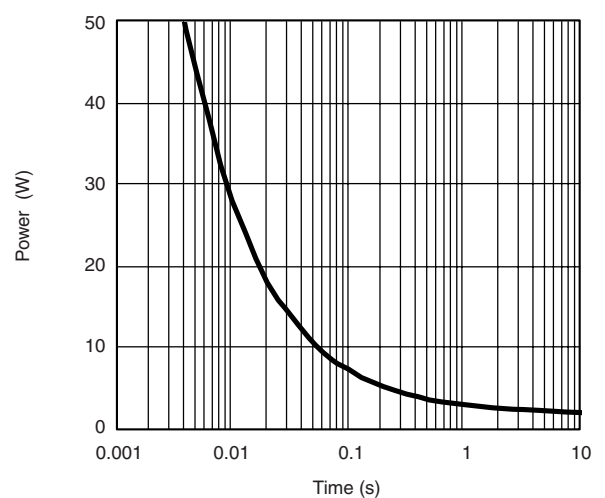
Source-Drain Diode Forward Voltage



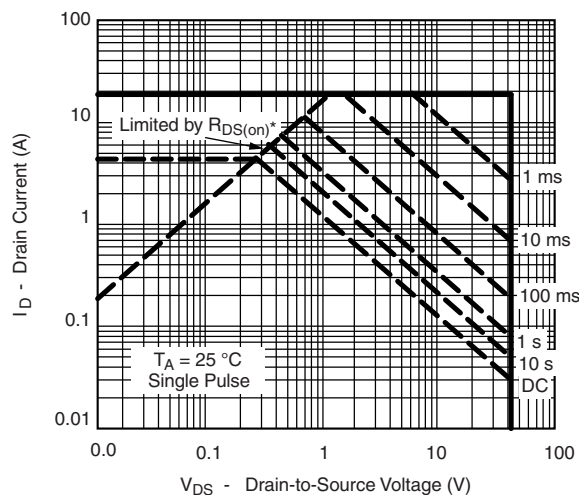
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

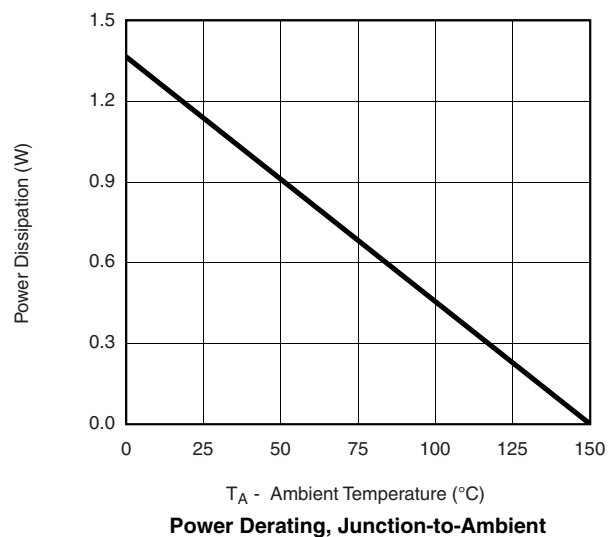
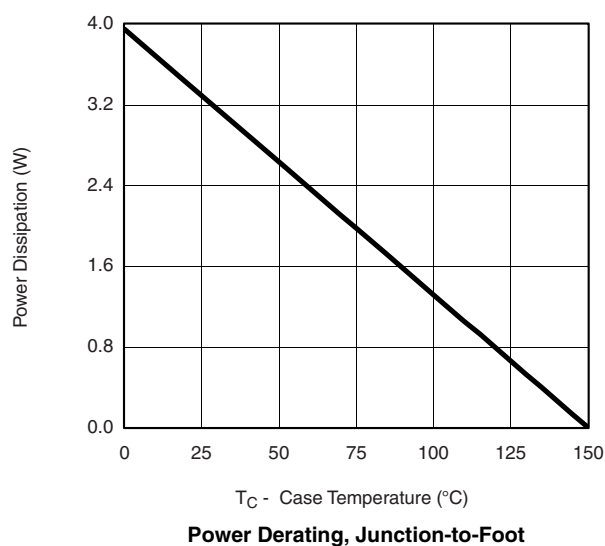
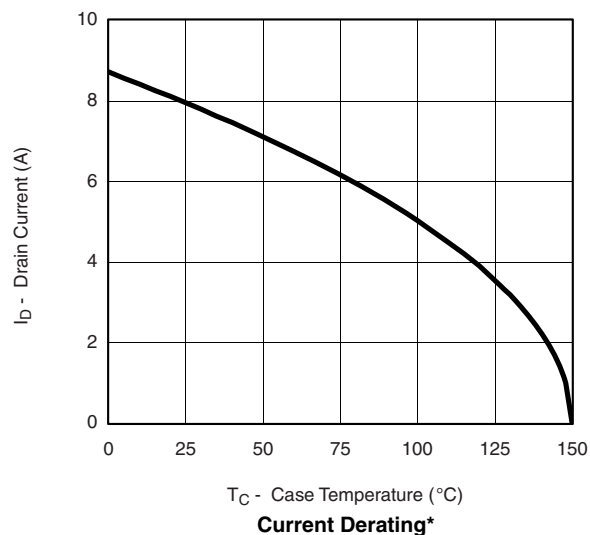


Single Pulse Power, Junction-to-Ambient



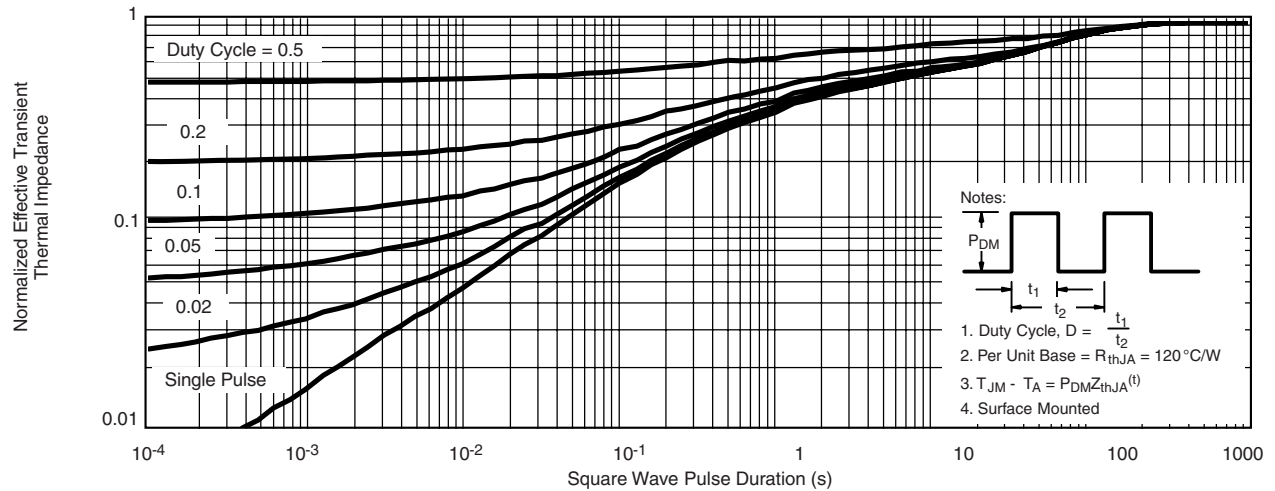
* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

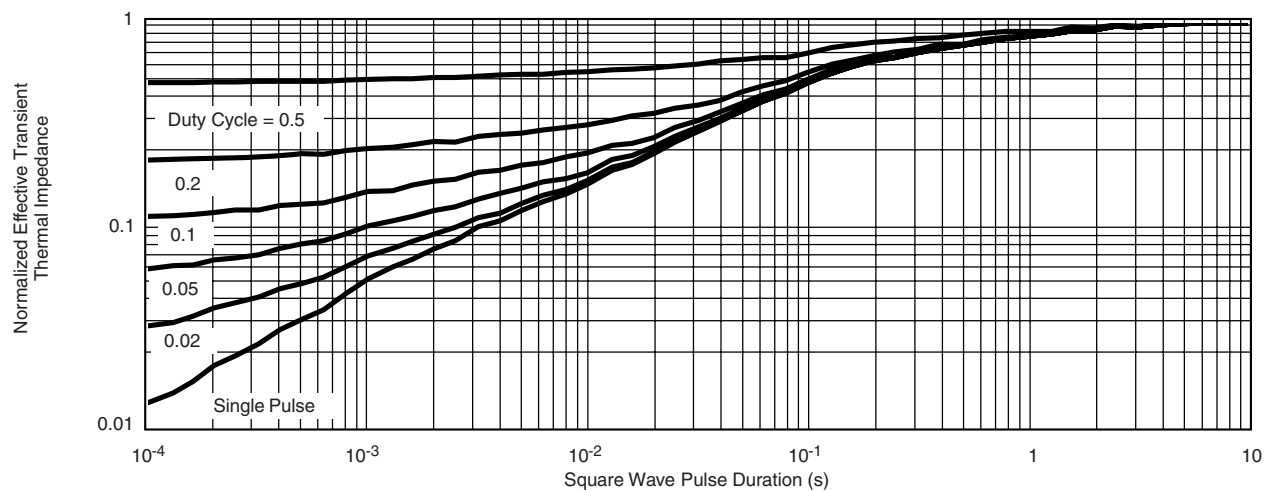
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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